1 Description

The RedRock® RR122-2E22-511 and RR122-2E23-511 are digital magnetic sensors ideal for use in medical, industrial, automotive, and consumer applications. It is based on patented Tunneling Magnetoresistance (TMR) technology with seamless CMOS integration.

The RR122-2E22-511 and RR122-2E23-511 feature an operate sensitivity of 15 G (1.5 mT), with a unipolar magnetic field response. They offer a wide supply voltage range from 1.7 up to 5.5 V, ideal for applications ranging from small battery-powered electronics to industrial machinery. They have the world's lowest average current drain (100nA) for an active magnetic sensor operating at 10 Hz and high operating temperature ranges from -40°C up to +125°C .

2 Features

- Operate sensitivity of 15 G
- Lowest Average Current of 100 nA
- Wide Supply Voltage range of 1.7V – 5.5V
- Unipolar Push-Pull Response
- Operating Frequency of 10 Hz
- Temperature Rated up to 125°C
- RoHS & REACH Compliant

3 Applications

- Proximity Detection
- Rotary Sensing
- Fluid Level Detection
- Door & Lid Closure Detection
- Utility Meters
- Portable Medical Devices
- Motor Controllers
- Consumer Electronics
- Wake-Up µProcessor

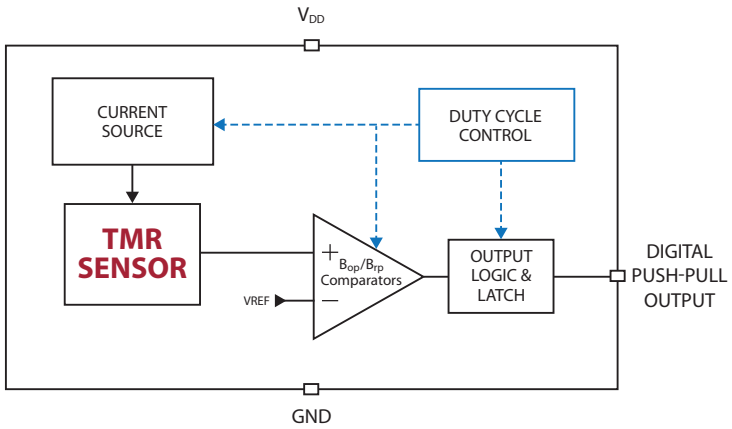
Device Information

Part Series	Package	Body Size (mm)	Temp Rating °C
RR122-2E22-511	SOT-23-3	2.9 x 1.6 x 1.2	-40 to +85
RR122-2E23-511	SOT-23-3	2.9 x 1.6 x 1.2	-40 to +125

Device Packages



Functional Block Diagram for Digital Push-Pull Output



Device Nomenclature

Ordering Information

RR122-X X X X-Y Y Y

Series

Magnetic Polarity Response
1 = Omnipolar
2 = Unipolar
3 = Bipolar/Latch

Magnetic Sensitivity (G)
A: Op 9, Rel 5
B: Op 30, Rel 20
C: Op 10, Rel -10
E: Op 15, Rel 10
F: Op 70, Rel 50
G: Op 100, Rel 70

Clock Frequency (Hz)
1: 2
2: 10
3: 20
5: 250
6: 500
7: 2500
9: 10000
U: 100+Turbo (10000)

Package
1: SOT-23-3
2: LGA-4
5: SOT-23-5

Output Response
1: Active Low

Supply Voltage (V)
5: 1.7 – 5.5

Temp Rating (°C)
2: -40 – +85
3: -40 – +125

© Coto Technology 2022. All rights reserved.

4 Specifications

4.1 Absolute Environmental Ratings[1,2]

Parameters	Units	Min	Typ	Max
Operating Temperature (T_{OP}) (RR122-2E22-511)	°C	-40		+85
Operating Temperature (T_{OP}) (RR122-2E23-511)	°C	-40		+125
Storage Temperature (T_{STG})	°C	-65		+150
Junction Temperature (T_J)	°C			+150
Soldering Temperature (3 cycles, 1 min.) (T_{SOL})	°C			+260
ESD Level Human Body Model per JESD22-A114	V	±4000		
ESD Level Charged Device Model (CDM) per JESD22-C1010	V	±500		
Junction-to-Ambient Thermal Resistance (SOT-23-3)	°C/W		202	
Maximum Magnetic Field Exposure (B_{MAX})	G			±2000

4.2 Absolute Electrical Ratings[1,2]

Parameters	Units	Min	Typ	Max
Supply Voltage (V_{DD})	V	-0.3		6.0
Push-pull Output (Active Low)(V_{OUT_PP})	V	-0.3		V_{DD}
Input and Output Current (I_{IN}/I_{OUT})	mA			±20

4.3 Operating Electrical Characteristics for RR122-2E22-511 and RR122-2E23-511[3]

Parameters	Units	Min	Typ	Max
Supply Voltage (V_{DD})	V	1.7	3.0	5.5
Power-On Time (t_{ON})(V_{DD} > 90%)	µs		50	75
Peak Power-On Current	mA			1.4
Output Voltage (High) (V_{OUTH})	V	90% V_{DD}		
Output Voltage (Low) (V_{OUTL})	V			10% V_{DD}
Under Voltage Lockout Threshold Rising V_{DD} ($V_{UVLO-RISE}$)	V		1.60	1.64
Under Voltage Lockout Threshold Falling V_{DD} ($V_{UVLO-FALL}$)	V	1.44	1.53	
Under Voltage Lockout Hysterisis ($V_{UV-HYST}$)	mV		70	
Average Supply Current @ V_{DD} = 1.7 V, f_s = 10 Hz	nA		100	
Average Supply Current @ V_{DD} = 3.0 V, f_s = 10 Hz	nA		135	

Notes:
1. Exceeding Absolute Ratings may cause permanent damage to the device.
2. Unless otherwise specified, all characteristics are measured at 25°C.
3. Unless otherwise specified, V_{DD} = 1.7 V to 5.5 V, T_A = -40°C to +85°C (2E22), -40°C to +125°C (2E23). Typical values are V_{DD} = 3.0 V and T_A = +25°C.

ESD Note: This product uses semiconductors that can be damaged by electrostatic discharge (ESD). When handling, proper ESD precautions should be taken to avoid performance degradation or loss of functionality. Damage due to inappropriate handling is not covered under warranty.

4 Specifications (cont.)

4.4 Operating Characteristics for RR122-2E22-511 and RR122-2E23-511[1,2]

Parameters	Units	Min	Typ	Max
Switching Frequency (f_{SW})	Hz	6	10	14
Active Mode Time (t_{ACT})	µs		2.6	
Idle Mode Time (t_{IDLE})	ms	71	100	166
Operate Point (B_{OPN})	G		N/A	
Operate Point (B_{OPS})	G	-19	-15	-11
Release Point (B_{RPN})	G		N/A	
Release Point (B_{RPS})	G	-14	-10	-6
Hysteresis (B_{HYST})[4]	G	3	5	

Notes:

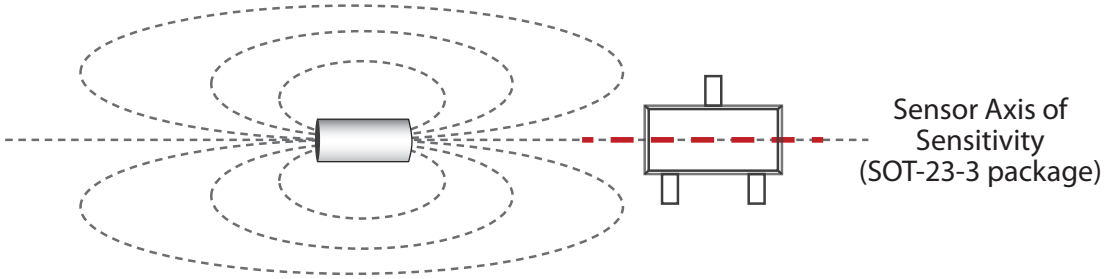
1. Unless otherwise specified, V_{DD} = 1.7 V to 5.5 V, T_A = -40°C to +85°C (2E22), -40°C to +125°C (2E23). Typical values are V_{DD} = 3.0 V and T_A = +25°C.
2. Conditions: $B_{HYST} = | B_{OP} - B_{RP} |$

ESD Note: This product uses semiconductors that can be damaged by electrostatic discharge (ESD). When handling, proper ESD precautions should be taken to avoid performance degradation or loss of functionality. Damage due to inappropriate handling is not covered under warranty.

5 Magnetic Response

For more information please contact Coto Technology at RedRock@cotorelay.com.

5.1 Axis of Sensitivity

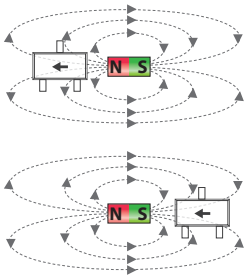
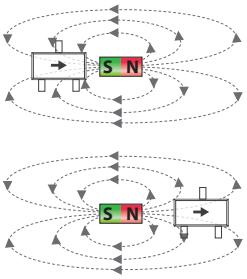


Note: The most straightforward way of aligning a magnet with a TMR sensor is by lining up the magnet's magnetization axis with the sensor's Axis of Sensitivity (as shown above). However, there are many other alignments and orientations that will also achieve proper operation. For any questions, or to learn more, please contact Coto Technology.

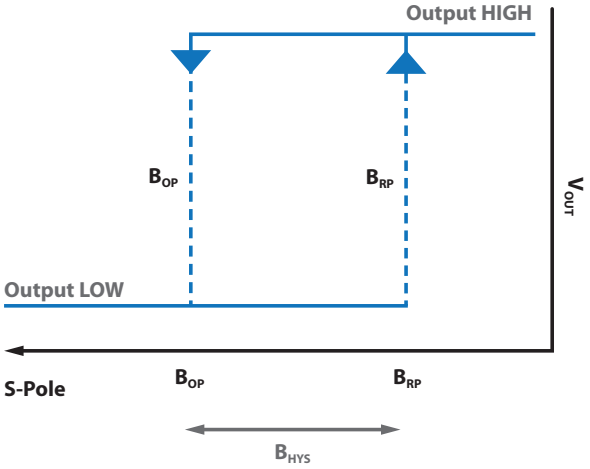
© Coto Technology 2022. All rights reserved.

5 Magnetic Response (cont.)

5.2 Magnetic Response Table (SOT-23-3 package)

	Step 1: Sensor is powered without magnetic field.	**Step 2:** Magnet applied, polarity **North**.	**Step 3:** Magnet removed.	**Step 4:** Magnet applied, polarity **South**.	**Step 5:** Magnet removed.
Scenario					
UNIPOLAR SENSOR OUTPUT	HIGH	HIGH	HIGH	**LOW** (Activated)	HIGH

5.3 Magnetic Response Output Diagram



 © Coto Technology 2022. All rights reserved.

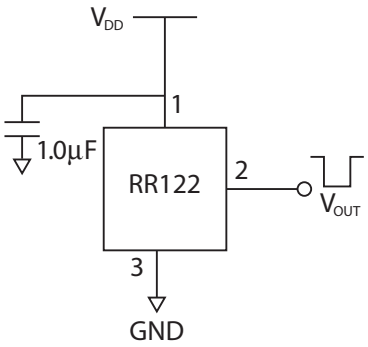
redrock@cotorelay.com | www.cotorelay.com

6 Application Information

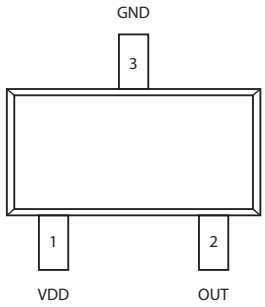
RR122 Push-Pull Output Application Circuit

The output voltage on the RR122 is active low, meaning that while a sufficiently strong magnetic field is present, the output voltage is low. The output voltage can be connected to a digital I/O pin on a microcontroller. A decoupling capacitor between the supply voltage and ground is required with placement close to the magnetic sensor. A typical capacitor value of 1.0 µF will suffice.

6.1 Application Circuit (SOT-23-3)



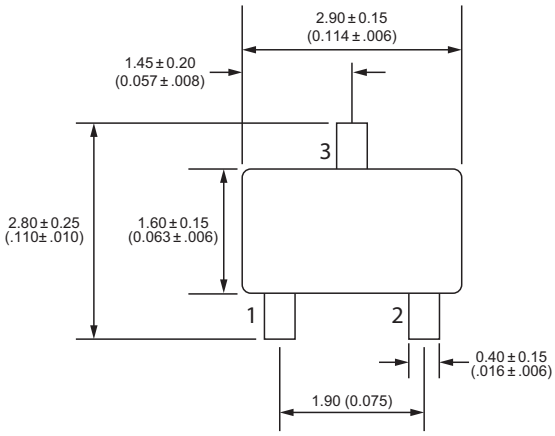
6.2 Package Pinout (SOT-23-3)



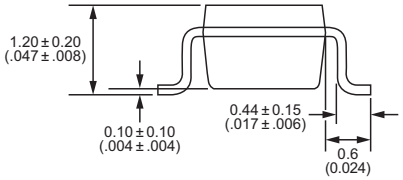
7 Dimensions *Millimeters (Inches)*

SOT-23-3 Package

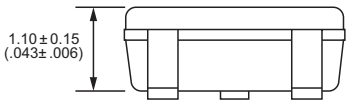
Top View



End View

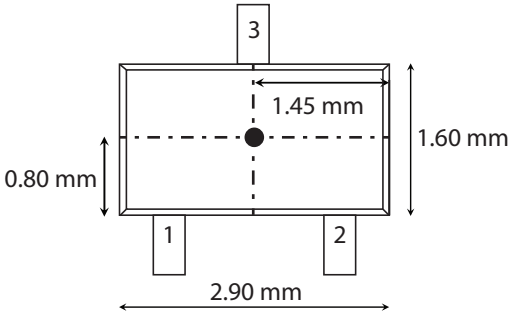


Side View

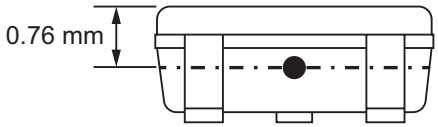


8 TMR Sensor Location

8.1 SOT-23-3 Package



8.2 SOT Package - Side View



© Coto Technology 2022. All rights reserved.

9 TMR Sensor & Switch Packaging

9.1 SOT-23-3 Tape & Reel Packaging

Standard packaging is Tape & Reel containing 3,000 pieces. MSL Rating is 1.

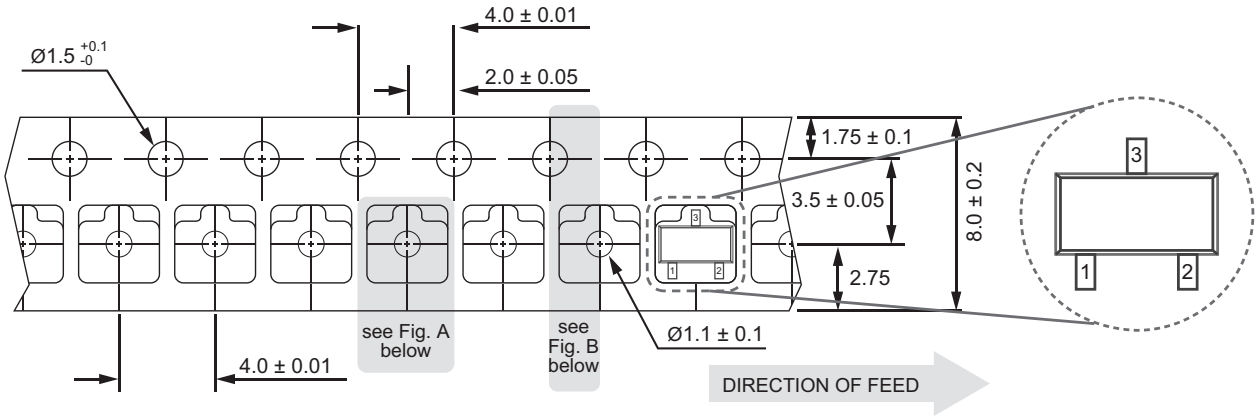


Fig. A

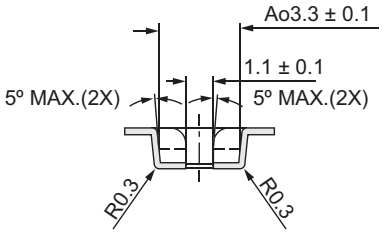
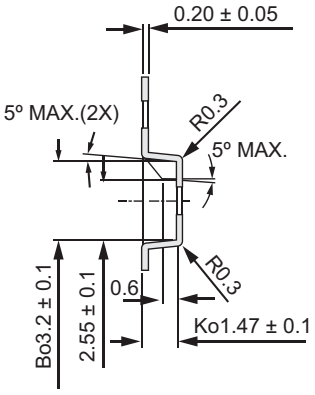
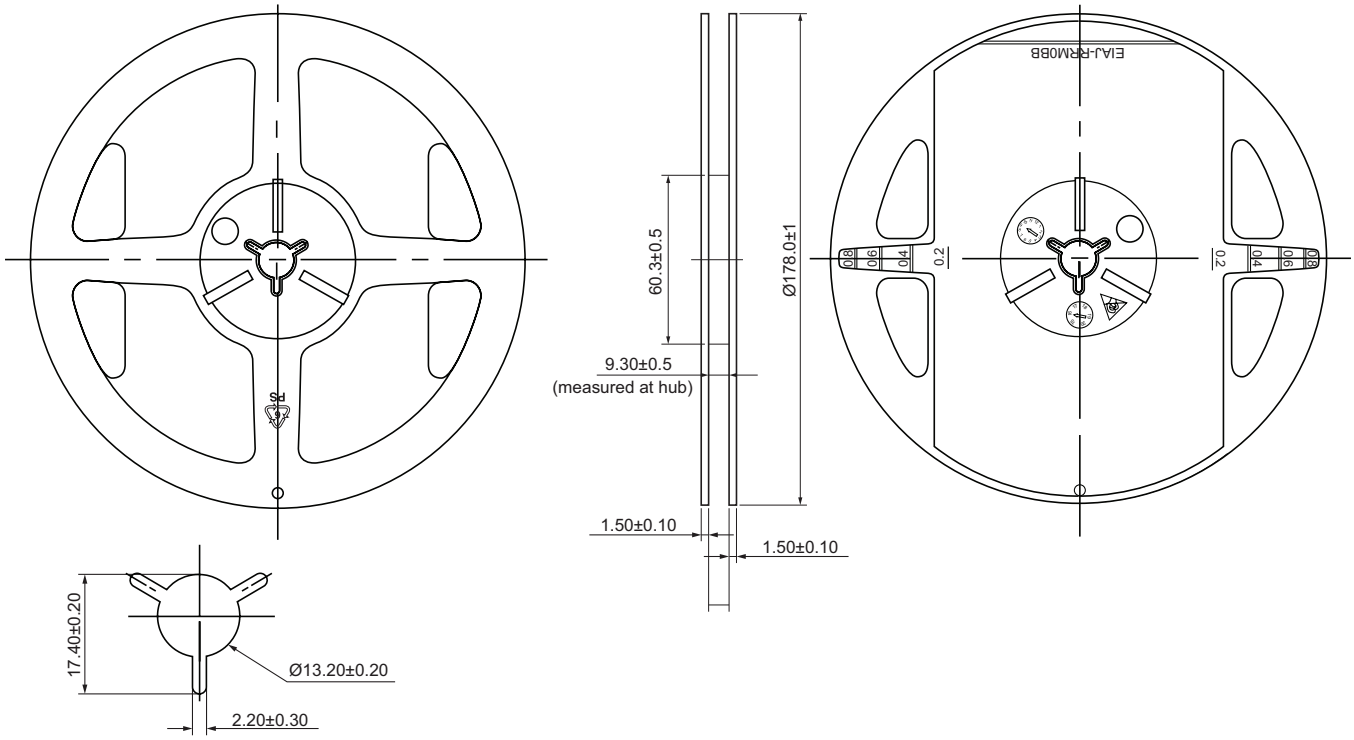


Fig. B



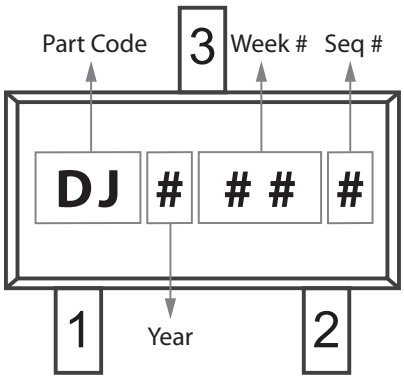


redrock@cotorelay.com | www.cotorelay.com

9 TMR Sensor & Switch Packaging

9.2 RedRock Package Codes

RR122-2E22-511 / RR122-2E23-511 (SOT-23-3)



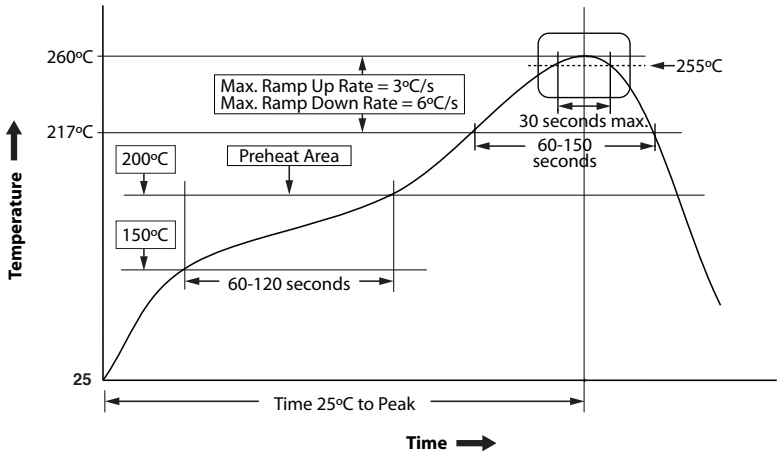
9.3 RedRock TMR Packaging

Box Dimensions – 14x10x6 inches
- Fits 1 to 3 reels = 3000 to 9000 pcs
- Weight for 3000 pcs = 0.90 kilos
- Weight for 9000 pcs = 1.00 kilos

Box Dimensions – 18x14x12 inches
- Fits 4 to 24 reels = 12000 to 72000 pcs
- Weight for 12000 pcs = 1.50 kilos
- Weight for 72000 pcs = 4.90 kilos

10 Suggested Pb-Free Reflow Profile

Notes:
1. Fully compatible with standard no-lead solder profile, 260°C for 30 seconds max (3 cycles max).
2. Profile shown as example. Users are advised to develop their own board-level profile.
3. Suggested Pb-free reflow profile derived from IPC/JEDEC J-STD-020E.
4. Temperature tolerance: +0°C, as measured at any point on the package or leads
5. MSL rating of 1 (SOT-23-3 only) compatible with J-STD-020 or equivalent.
6. All temperatures refer to the center of the package, measured on the package body surface that is facing up during assembly reflow (e.g., live-bug). If parts are reflowed in other than the normal live bug assembly reflow orientation (i.e., dead-bug), Tp shall be within ± 2°C of the live bug Tp and still meet the Tc requirements, otherwise, the profile shall be adjusted to achieve the latter. To accurately measure actual peak package body temperatures, refer to JEP140 for recommended thermocouple use.
7. Reflow profiles in this document are for classification/preconditioning and are not meant to specify board assembly profiles. Actual board assembly profiles should be developed based on specific process needs and board designs and should not exceed the parameters in this table.

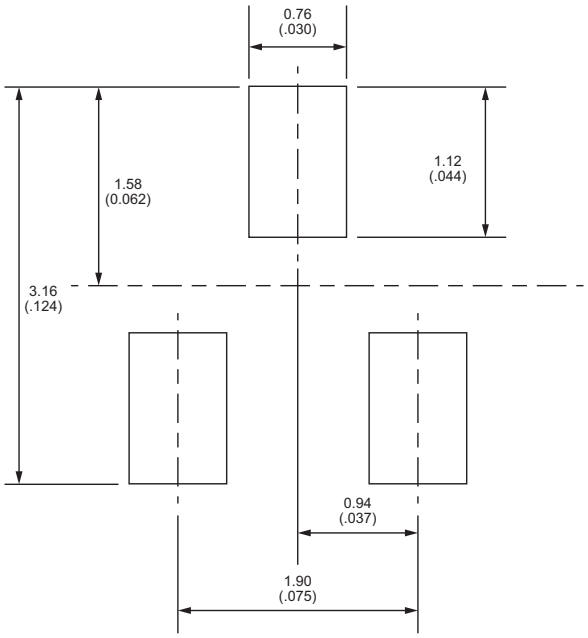


© Coto Technology 2022. All rights reserved.

11 Suggested Solder Pad Layout

Dimensions in mm (inches)

SOT-23-3 Solder Pad Layout



redrock@cotorelay.com | www.cotorelay.com

Revision History

	Date	Description
1	12/14/2021	Corrected Misleading Elements in Table 4.3
2	07/25/2022	Revised/expanded Magnetic Response Section (Section 5)
3	07/25/2022	Removed sections 7 and 10, consolidating information within new Section 5
4	07/25/2022	Modified packaging drawings (9.1)
5	07/25/2022	Added RedRock Package Code section (9.2)
6	07/25/2022	Added Package Pinouts (Section 6)
7	07/28/2022	Modified Average Supply Current (Table 4.3)
8	07/28/2022	Modified Active Mode Time (Table 4.4)
9	07/29/2022	Added Supply Voltage Typical Value (Table 4.3)
10	07/29/2022	Modified UVLO Falling Value (Table 4.3)

© Coto Technology 2022. All rights reserved.